

# 2EZ11~2EZ39

**GLASS PASSIVATED JUNCTION SILICON ZENER DIODES** 

## Voltage Range 11-39 Volts Power 2.0mWatts

### Features

- \* Low profile package
- \* Built-in strain relief
- \* Glass passivated iunction
- \* Low inductance
- \* Typical I<sub>D</sub> less than 1.0  $\mu$  above 11V
- \* Plastic package has Underwriters Laboratory Flammability Classification 94V-O
- \* High temperature soldering : 260°C /10 seconds at terminals Pb free product are available : 99% Sn above meet Rohs environment substance directive request

## **Mechanical Data**

Case: JEDEC DO-15, Molded plastic over passivated junction Terminals: Solder plated, solderable per MIL-STD-202G, Method 208 Polarity: Color band denotes positive end (cathode) Standard packing: 52mm tape Weight: 0.015 ounce, 0.04 gram



## **Maximum Ratings and Electrical Characteristics**

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	Value	Units	
Pwak Pulse Power Dissipation on TA=50 $^{\circ}$ C (Notes A) Derate above 70 $^{\circ}$ C	Po	2 24.0	W atts mW/ °C	
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC method)	IFSM	15	Amps	
Operating Junction and Storage Temperature Range	TJ,TSTG	-55 to + 150	°C	

### NOTES:

1.Mounted on 5.0mm2 (.013mm thick) land areas.

2.Measured on8.3ms, and single half sine-wave or equivalent square wave ,duty cycle=4 pulses per minute maximum



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Part Number	Nominal Zener Voltage			Maximum Zener Impedance				Leakage Current	
	Vz @ Izt			Zzt @ Izt	lzт	Zzк @ Іzк	lzк	Ir @Vr	
	Nom. V	Min. V	Max. V	Ohms	mA	Ohms	mA	uA	V
3.0 Watt ZENER									
2EZ11	11.0	10.05	11.6	4.0	45.5	700	0.25	1.0	8.4
2EZ12	12.0	11.4	12.6	4.5	41.5	700	0.25	1.0	9.1
2EZ13	13.0	12.4	13.7	5.0	38.5	700	0.25	0.5	9.9
2EZ14	14.0	13.3	14.7	5.5	35.7	700	0.25	0.5	10.6
2EZ15	15.0	14.3	15.8	7.0	33.4	700	0.25	0.5	11.4
2EZ16	16.0	15.2	16.8	8.0	31.2	700	0.25	0.5	12.2
2EZ17	17.0	16.2	17.9	9.0	29.4	750	0.25	0.5	13.0
2EZ18	18.0	17.1	18.9	10.0	27.8	750	0.25	0.5	13.7
2EZ19	19.0	18.1	20.0	11.0	26.3	750	0.25	0.5	14.4
2EZ20	20.0	19.0	21.0	11.0	25.0	750	0.25	0.5	15.2
2EZ22	22.0	20.9	23.1	12.0	22.8	750	0.25	0.5	16.7
2EZ24	24.0	22.8	25.2	13.0	20.8	750	0.25	0.5	18.2
2EZ27	27.0	25.7	28.4	18.0	18.5	750	0.25	0.5	20.6
2EZ28	28.0	26.6	29.4	19.0	17.0	750	0.25	0.5	21.0
2EZ30	30.0	28.5	31.5	20.0	16.6	1000	0.25	0.5	22.5
2EZ33	33.0	31.4	34.7	23.0	15.1	1000	0.25	0.5	25.1
2EZ36	36.0	34.2	37.8	25.0	13.9	1000	0.25	0.5	27.4
2EZ39	39.0	37.1	41.0	30.0	12.8	1000	0.25	0.5	29.7



### NOTES:

Since the actual voltage available from a given zener diode is temperature dependent, it is necessary to determinejunction temperature under any set of operating conditions in order to calculate its value. The following procedure is recommended: Lead Temperature,  $T_L$ , should be determined from:

### $TL=\Theta LA PD + TA$

 $\theta$  L<sub>A</sub> is the lead-to-ambient thermal resistance (°C/W) and Pd is the power dissipation. The value for  $\theta$ L will vary and depends on the device mounting method.  $\theta$ L is generally 30-40°C/W for the various clips and tie points in common use and for printed circuit board wiring the temperature of the lead can also be measured using a thermocouple placed on the lead as close as possible to the tie poin The thermal mass connected to the tie point is normally large enough so that i t will not significantly respond to heat surges generated in the diode as a result of pulsed operation once steady-state conditions are achieved. Using the measured value of TL, the junction temperature may be determined by:

### $T_J = T_L + \Delta T_{JL}$

 $\Delta T$  JL is the increase in junction temperature above the lead temperature and may be found from Figure 2 for a train of power puls or from Figure 10 for dc power.

### $\Delta T_{JL} = \theta J_L P_D$

For worst-case design, using expected limits of Iz, limits of P and the extremes of  $T_J(\Delta T_J)$  may be estimated. Changes in volta Vz, can then be found from:

$$\Delta V = \Theta V Z \Delta T J$$

 $\theta$  Vz, the zener voltage temperature coefficient, is found from Figures 5 and 6.

Under high power-pulse operation, the zener voltage will vary with time and may also be affected significantly by the zener resis for best regulation, keep current excursions as low as possible.

Data of Figure 2 should not be used to compute surge capa-bility. Surge limitations are given in Figure 3. They are lower than be expected by considering only junction temperature, as current crowding effects cause temperatures to be extremely high in spots resulting in device degradation should the limits of Figure 3 be exceeded.

Http://www.upm.com.tw	E -mail:upm.tw@msa.hinet.net

